**Taiwan Semiconductor Manufacturing Company, Ltd.**


# Personnel Information Form

人事資料表

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| **\* Please fill out the form in English or Chinese 請使用英文或中文填寫此資料表****\* TSMC will collect, process and use the personal information you provided in this form in accordance with Personal Information Protection Act (Taiwan). For more detailed information, please refer to the last page of this form. 本公司將依照個人資料保護法蒐集、處理與利用您以下所提供的個人資料。詳細資訊請參照本人事資料表最末頁之說明。** |
| **Job Applied For**申請職務 | **1.**  | **2.** |
| A. General Information 個人基本資料 |
| **Name**姓名 | **Chinese**中文 |  | Nationality國籍 | 🞏 **R.O.C.** 中華民國 |
| **English**英文 |  | 🞏  |
| **Have you ever changed your name?**您是否曾更改過姓名？🞏 **No**否🞏 **Yes**是 **Name before changed**原名：  |
| **I.D. No.**身分證字號 |  |  |  |  |  |  |  |  |  |  | Phones電話 | (Tel)**(Cell)** |
| E-mail Address電子郵件 |  |
| **Permanent Address**戶籍地址 | 🞏🞏🞏 |
| Mailing Address通訊地址 | 🞏🞏🞏 |
| **Military Service**兵役狀況 | 🞏 Complete Service役畢：服役期間-自\_\_\_\_年＿＿月至\_\_\_\_年＿＿月 🞏 In Service服役中：服役期間-自\_\_\_\_年＿＿月至\_\_\_\_年＿＿月 🞏 Exemption from Service免役：免役原因-＿＿＿＿＿＿＿＿＿＿＿🞏 Have not Perform Military Obligation未役：預計入伍時間- \_\_\_\_年\_\_\_\_月 |
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| B. Education, Specialty & Language Ability 教育、專長與語文能力 |
| **Grade**階段 | **Name of School**學校名稱 | **Major**科系 | **From**起 | **To**迄 | **Graduated**是否畢業 | Type日/夜間部 | Highest Degree最高學歷 |
| **M**月 | **Yr**年 | **M**月 | **Yr**年 | **Yes** | **No** |
| High School 高中(職) |  |  |  |  |  |  |  |  | 🞏**Day** 日間部🞏**Night**夜間部 |  |
| **Jr. College**專科 |  |  |  |  |  |  |  |  | 🞏**Day** 日間部🞏**Night**夜間部 |  |
| **University**大學 |  |  |  |  |  |  |  |  | 🞏**Day** 日間部🞏**Night**夜間部 |  |
| **Post Graduate****(Master)**研究所(碩士) |  |  |  |  |  |  |  |  |  |  |
| **Post Graduate****(PhD)**研究所(博士) |  |  |  |  |  |  |  |  |  |  |
| **Other**其他 |  |  |  |  |  |  |  |  |  |  |
| Describe any special vocational or technical training and specialized knowledge/skill 請說明您的專業知識與技能**In summary, key words of your expertise are:** 您專業技能的關鍵字詞為何(註：關鍵字有助加速將您的履歷派送至適合職缺) |
| **Academic Ranking:** select the class academic ranking 個人在學成績排名1. 大學 Bachelor : **□ Top 10% □11~20% □21~50% □51%~100%**
2. 研究所Master : **□ Top 10% □11~20% □21~50% □51%~100%**
 |
| **Language Ability:** indicate the language and your proficiency, i.e. Excellent, Good, Useful, A little, Not at all.語文能力：請以極佳、佳、普通、略通或不通說明您對該語文的熟練程度 |
| **Second Language and so on**第2、3...外國語 | **Listening**聽 | **Speaking** 說 | **Reading**讀 | **Writing** 寫 | **Remarks**備註 |
| **1. English** |  |  |  |  |  |
| **2.** |  |  |  |  |  |
| **3.** |  |  |  |  |  |

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| **C. Academic Achievement & Honor** 學術成就及獲獎紀錄 |
| 1. **Honor/Award: indicate international or national contest awards, e.g. Presidential Award, Phi Tau Phi Scholastic Honor.**

**獲獎榮譽:個人書卷獎、斐陶斐榮譽學員會員、或其他國際性/全國性競賽獲獎紀錄** |
| **Name of Honor/Award**獎項名稱 | **Qualification for the Honor/Award**獎項競賽資格 | **Prize**得獎名次/獎項 | **Category**性質 | **Year**發表年 |
|  |  |  | 🞏Domestic🞏International |  |
|  |  |  | 🞏Domestic🞏International |  |
| 1. **Publication on A Class Journal (e.g. Nature, IEEE, SPIE, JACS…etc.)**

**A級期刊論文 (例如: Nature, IEEE, SPIE, JACS 等)** |
| **Journal**期刊名稱 | **Title of the Publication**論文題目 | **1st author or 1st author second to Professor**第一作者或次於教授後之第一作者 | **Year**發表年 |
|  |  | 🞏Yes 🞏No |  |
|  |  | 🞏Yes 🞏No |  |
| 1. **Oral Publication on A Class Conference (e.g. Nature, IEEE, SPIE, JACS…etc.)**

**口頭發表之A級研討會論文 (例如: Nature, IEEE, SPIE, JACS 等)** |
| **Conference**研討會名稱 | **Title of the Oral Publication**口頭發表之論文題目 | **1st author or 1st author second to Professor**第一作者或次於教授後之第一作者 | **Location**地點 | **Year**發表年 |
|  |  | 🞏Yes 🞏No |  |  |
|  |  | 🞏Yes 🞏No |  |  |

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| 1. **Invention /Patent**

**發明及專利** |
| Patent Name發明/專利名稱 | **Date of Issue**核准日 | **Patent Certificate No.**證號 | **Country of Issue**核發國 |
| (1) |  |  |  |
| (2) |  |  |  |
| **5. License or Certificate****專業證照** |
| License or Certificate專業證照或檢定證書 | **Date of Issue**發照日 | **Certificate No.**證照字號 | **Remarks**備註 |
| (1) |  |  |  |
| (2) |  |  |  |
| **6. Experience in Participating in Associations****社團經驗** |
| Name of Association社團名稱 | **Title**職稱 | **Year**年 |
| (1) |  |  |
| (2) |  |  |

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| D. Working Experience : It is at your discretion to provide the information of supervisor and compensation. 工作經驗:直屬主管及薪資資料請自行斟酌是否填寫 |
| From 起 | To 迄 | Title /On Grade Year職稱/在職年資 | **Co. Name**公司名稱(請填入公司全名) | **Co. Location**(Country)公司所在地點 | **Supervisor**直屬主管 | **Compensation** 薪資 | **Reason** **for Leaving**離職原因 |
| **M**月 | **Yr**年 | **M**月 | **Yr**年 | **Name**姓名 | **Title**職稱 | **Monthly Base Salary** 月薪 | **Allowance****/Bonus** 津貼/獎金 | **Others**其他 |
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| **May we contact your present employer?** 台積公司是否可與您的現任雇主聯絡查證 🞏 **No**否🞏 **Yes**是**We shall not do so without your consent.** 未經您同意台積公司絕不會聯絡您的現任雇主 |
| **Describe your experience, major achievement during each of the period mentioned above.**請摘要您於上述各職務的主要成就 |
| E. Others 其他 |
| **Do you have any relatives or friends working in tsmc?** 目前是否有任何親屬、朋友任職於台積公司？🞏 **No** 否🞏 **Yes** 是 **If yes, please specify the name, relation and dept.** 如有，請列出姓名、關係及任職部門 |
| Name 姓名 | **Relation**關係 | **Department**部門 | Name 姓名 | **Relation**關係 | **Department**部門 |
|  |  |  |  |  |  |
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|  |  |  |  |  |  |
| **Reference Check :** Please provide minimum of three names. Your supervisor(s), research advisor(s) or teacher(s) must be included in. 資歷查核: 請至少提供三位查核對象，其中至少含直屬主管、論文指導教授或授課教師 |
| Name 姓名 | **Relation**關係 | **Company / Dept.**公司/部門 | **Title**職稱 | **Contact**聯絡方式 |
|  |  |  |  | (Tel)(Cell) | E-mail: |
|  |  |  |  | (Tel)(Cell) | E-mail: |
|  |  |  |  | (Tel)(Cell) | E-mail: |
| What do you expect most of the job that you are applying for? Please tick and explain briefly. 您對下一份工作最重視的項目為何，請勾選並簡要說明 |
| Aspect 項目 | **Why** 原因 | **Aspect**項目 | **Why**原因 |
| 🞏 **Greater responsibility** 擔負更大的責任 |  | 🞏 **New field of work**新領域 |  |
| 🞏 **Salary**薪資 |  | 🞏Opportunities of learning & development訓練與發展的機會 |  |
| 🞏 **Job security**工作保障 |  | 🞏 Different location工作地點 |  |
| 🞏 **Others**其他 |  |
| When will you be available for the new job if you are recruited? 如獲任用何時可以報到？ Yr年 M月 Date日 | Expected Salary期望薪資 | NT$ |
| Which channel did you learn the job opening? 您自何處得知此職缺🞏 **Campus** 學校🞏 **Job bank**人力銀行🞏 **Newspaper ad.**報紙廣告🞏 **Magazines** 雜誌 🞏 **Friends / Relatives**親友🞏 **Teachers/Advisors** 授課教師/指導教授🞏 **Employment Service Office** 就業服務站 🞏 **Others** 其他，請說明**\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_** |
| **Additional information you wish to add** 其他補充資訊 |

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| F. Optional Information: The following information is optional. TSMC provides equal employment opportunity to all job applicants in compliance with the Employment Service Act of Taiwan (R.O.C.).選填資訊: 以下資訊可依個人意願填答。依據就業服務法，台積公司提供求職者公平的求職機會。 |
| **Personal Information** 個人資料 | Photo照片 |
| **Birth Date**出生日期 |  **mm/dd/yyyy**西元月/日/年 | Gender性別 | 🞏 **Male**男🞏 **Female**女 |
| **Marital Status**婚姻 | 🞏 **Single**單身🞏 **Married**已婚 |
| **Interests & Hobbies**興趣、嗜好 |  |
| **Family Information**: including parents, guardian, spouse, children & siblings.家庭資料:父母、監護人、配偶、子女及兄弟姊妹 |
| **Relationship**關係 | **Name** 姓名 | **Age**年齡 | **Occupation** 職業 | **City of Residence**居住城市 |
| **Father**父 |  |  |  |  |
| **Mother**母 |  |  |  |  |
| **Spouse**配偶 |  |  |  |  |
| **Children** 子女 |  |  |  |  |
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| **Are you qualified for the below status as specified by law?** 您是否具有以下之法定身分? 🞏 **Indigenous people**原住民 🞏 **Individuals with disabilities**身心障礙者**We welcome applicants with any of the above specifications.** 台積公司歡迎具有以上法定身份之求職者求職。 |
| **Have you ever been prosecuted or indicted for any intentional crime?** 您是否曾因刑事故意犯罪而遭受偵查或起訴？🞏 **No**否🞏 **Yes**是 **What**請說明 **\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_****Are you on the wanted list?** 是否遭任何國家通緝？🞏 **No**否🞏 **Yes**是 **What**請說明 **\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_** |

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| **I hereby authorize TSMC to verify the accuracy of all the statements made and the personal information provided in this Form (“Information”), and I fully understand that any falsification in this Form constitutes a sufficient and just cause for dismissal of my employment if hired.** **I hereby consent and authorize TSMC and its affiliated entities, employee welfare committees of TSMC and its affiliated entities, TSMC Education and Culture Foundation and any other third parties authorized by the above entity or entities to collect, process and use, domestically and internationally, the personal information that I provided or will provide for the purposes of TSMC's recruitment process, personnel management and business operation in accordance with relevant laws governing the protection of personal information, and to retain the information for at least 15 years after all the aforementioned purposes no longer exist.** **In addition, I have read the above statement and acknowledged that I understood and have been informed the purposes of collecting the Information, the classification of the Information, the time period, areas, targets and ways of using the Information, my rights under Article 3 of Personal Information Protection Act and the ways to exercise them, and the consequences if I choose not to provide the Information.** **本人謹此授權台積公司得就本人於此人事資料表中所提供之陳述與個人資料內容之正確性進行確認。本人充分瞭解在此人事資料表中所為之一切陳述如有虛偽不實，將足以構成終止聘僱合約之事由。****本人並特此同意及授權台積公司及其關係企業、台積公司及其關係企業之職工福利委員會、台積電文教基金會及以上公司及組織所委託之第三人為招募聘用、人事管理及業務執行之目的，在符合個人資料保護相關法令之範圍內，蒐集、於國內與國際間處理、利用本人已經提供及未來將提供的個人資料，並得於特定目的消失後保存至少十五年。****本人已詳閱上開內容，並確認本人已瞭解且已依個人資料保護法及相關法令之規定受告知本人事資料表內個人資料之蒐集目的、個人資料類別、利用之期間、地區、對象及方式、依個人資料保護法第三條規定得行使之權利及權利行使方式、及不提供本人本履歷表、人事資料表內個人資料時將對本人權益之影響。****Signature 簽名 Date 日期**  |
| **I hereby declare that I will comply with all TSMC regulations during my employment. In case of any violation, I agree to accept and be bound by applicable penalties as specified in the TSMC Work Rules and relevant rules.****本人同意並保證：本人於在職期間將遵守台積公司所有相關規定。如有違反，本人同意接受工作規則及其他相關規定之懲處。****Signature簽名 Date日期**  |